Diodes

Low–leakage switching diode
RLS139

●Applications

High speed switching

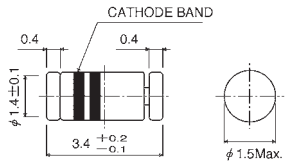
●Features

1) High reliability.
2) Small surface mounting type. (LLDS (LL–34))
1)2The typical reverse current is extremely low of 0.45nA.

●Construction

Silicon epitaxial planar

●External dimensions (Units: mm)



ROHM : LLDS
JEDEC : LL-34
Common : mini-MELF

●Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Peak reverse voltage	V_{RM}	90	V
DC reverse voltage	V_R	80	V
Peak forward current	I_{FM}	400	mA
Mean rectifying current	I_O	130	mA
Surge current (1 μs)	I_{surge}	600	mA
Power dissipation	P	300	mW
Junction temperature	T_j	175	℃
Storage temperature	T_{stg}	−65～+175	℃

●Cathode band colors

Type	1st Color Band	2nd Color Band
RLS139	Gray	Gray

●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_F	−	1.0	1.2	V	I_F=100mA
Reverse current	I_R	−	0.45	20	nA	V_R=30V
Capacitance between terminals	C_T	−	2	5	pF	V_R=0.5V, f=1MHz
Reverse recovery time	t_{rr}	−	30	50	ns	V_R=6V, I_F=10mA, R_L=50Ω

●Electrical characteristic curves (Ta = 25°C unless specified otherwise)

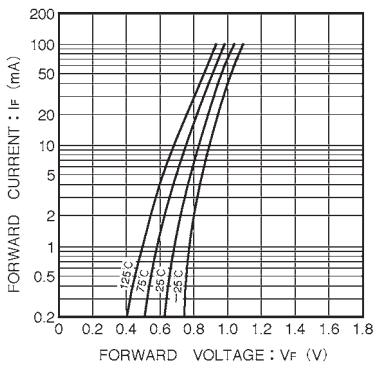


Fig. 1 Forward characteristics

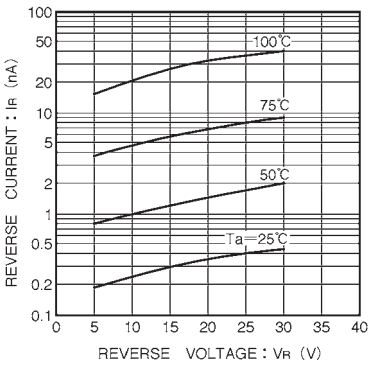


Fig. 2 Reverse characteristics

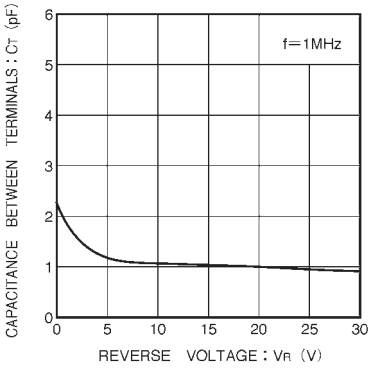


Fig. 3 Capacitance between terminals characteristics

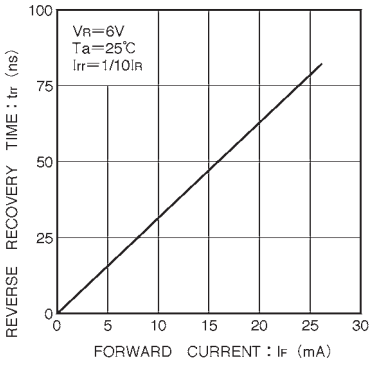


Fig. 4 Reverse recovery time characteristics

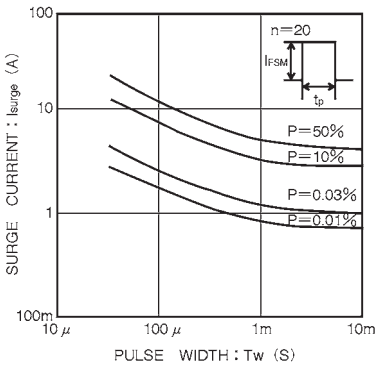


Fig. 5 Surge current characteristics

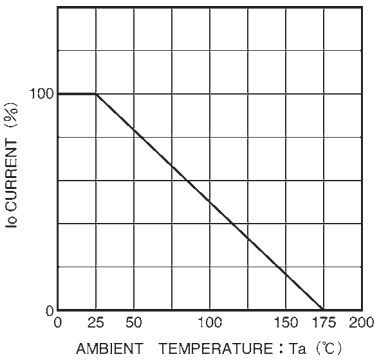


Fig. 6 Derating curve (mounting on glass epoxy PCBs)

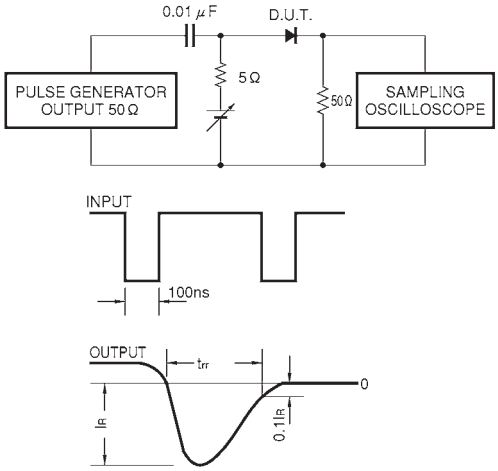


Fig. 7 Reverse recovery time (t_{rr}) measurement circuit